



### 400 W TVS in SMA







nanectional

**Product status links** 

SMAJ5.0A, SMAJ5.0CA,

SMAJ6.0A, SMAJ6.0CA,

SMAJ6.5A, SMAJ6.5CA,

SMAJ8.5A, SMAJ8.5CA,

SMAJ10A, SMAJ10CA,

SMAJ12A, SMAJ12CA,

SMAJ13A, SMAJ13CA,

SMAJ15A, SMAJ15CA,

SMAJ18A, SMAJ18CA,

SMAJ20A, SMAJ20CA,

SMAJ24A, SMAJ24CA,

SMAJ26A, SMAJ26CA,

SMAJ28A, SMAJ28CA

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SMAJ30A, SMAJ30CA, SMAJ33A, SMAJ33CA

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SMAJ40A, SMAJ40CA, SMAJ43A, SMAJ43CA,

SMAJ48A, SMAJ48CA

SMAJ58A, SMAJ58CA,

SMAJ70A, SMAJ70CA,

SMAJ85A, SMAJ85CA,

SMAJ100A, SMAJ100CA,

SMAJ130A, SMAJ130CA,

SMAJ154A, SMAJ154CA,

SMAJ170A, SMAJ170A,

SMAJ188A, SMAJ188CA.

#### **Features**

- Peak pulse power:
  - 400 W (10/1000 μs)
  - 2.3 kW (8/20 μs)
- Stand-off voltage range from 5 V to 188 V
- Unidirectional and bidirectional types
- Low leakage current:
  - 0.2 μA at 25 °C
  - 1  $\mu$ A at 85  $^{\circ}$ C
- Operating T<sub>i</sub> max: 150 °C
- JEDEC registered package outline

### Complies with the following standards

- UL94, V0
- J-STD-020 MSL level 1
- J-STD-002, JESD 22-B102 E3 and MIL-STD-750, method 2026 solderable matte tin plated leads
- JESD-201 class 2 whisker test
- IPC7531 footprint
- JEDEC registered package outline
- IEC 61000-4-4 level 4:
  - 4 kV
- IEC 61000-4-2, C = 150 pF R = 330 Ω exceeds level 4:
  - 30 kV (air discharge)
  - 30 kV (contact discharge)

#### **Description**

The SMAJ series is designed to protect sensitive equipment against electrostatic discharges according to IEC 61000-4-2 and MIL STD 883, method 3015, and electrical overstress according to IEC 61000-4-4 and 5. This device is more generally used against surges below 600 W (10/1000  $\mu$ s).

The Planar technology makes it compatible with high-end circuits where low leakage current and high junction temperature are required to provide long term reliability and stability. SMAJ devices are packaged in SMA (SMA footprint in accordance with IPC 7531 standard).



## 1 Characteristics

Table 1. Absolute maximum ratings (T<sub>amb</sub> = 25 °C)

Symbol		Value	Unit	
		IEC 61000-4-2 (C = 150 pF, R = 330 Ω)		
$V_{PP}$	Peak pulse voltage	Contact discharge	30	kV
		Air discharge	30	
P <sub>PP</sub>	Peak pulse power dissipation	T <sub>j</sub> initial = T <sub>amb</sub>	400	W
T <sub>stg</sub>	Storage temperature range	-65 to +150	°C	
Tj	Operating junction temperature range	-55 to +150	°C	
TL	Maximum lead temperature for solder	260	°C	

Figure 1. Electrical characteristics - parameter definitions

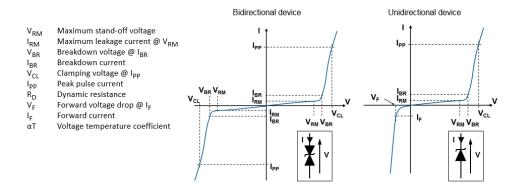
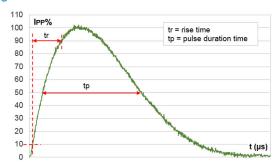


Figure 2. Pulse definition for electrical characteristics



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Table 2. Electrical characteristics - parameter values (T<sub>amb</sub> = 25 °C, unless otherwise specified)

	I <sub>RM</sub> max at V <sub>RM</sub>		V <sub>BR</sub> at I <sub>BR</sub> <sup>(1)</sup>		10 / 1000 μs		8	/ 20µs		_			
_					V <sub>CL</sub> <sup>(2)(3)</sup>	I <sub>PP</sub> <sup>(4)</sup>	R <sub>D</sub>	V <sub>CL</sub> <sup>(2)(3)</sup>	I <sub>PP</sub> <sup>(4)</sup>	R <sub>D</sub>	αΤ		
Туре	25 °C	85 °C		Min.	Тур.		Max.		Max.	Max.		Max.	Max.
	μ	μA V		,	,	mA	٧	Α	Ω	٧	Α	Ω	10 <sup>-4</sup> /°C
SMAJ5.0A/CA	20	50	5.0	6.40	6.74	10	9.2	43.5	0.049	13.4	174	0.036	5.7
SMAJ6.0A/CA	20	50	6.0	6.70	7.05	10	10.3	38.8	0.075	13.7	170	0.037	5.9
SMAJ6.5A/CA	20	50	6.5	7.20	7.58	10	11.2	35.7	0.091	14.5	160	0.041	6.1
SMAJ8.5A/CA	20	50	8.5	9.4	9.9	1	14.4	27.7	0.145	19.5	124	0.073	7.3
SMAJ10A/CA	0.2	1	10	11.1	11.7	1	17	23.5	0.201	21.7	106	0.089	7.8
SMAJ12A/CA	0.2	1	12	13.3	14.0	1	19.9	20.1	0.259	25.3	91	0.116	8.3
SMAJ13A/CA	0.2	1	13	14.4	15.2	1	21.5	18.6	0.298	27.2	85	0.132	8.4
SMAJ15A/CA	0.2	1	15	16.7	17.6	1	24.4	16.4	0.361	32.5	71	0.197	8.8
SMAJ18A/CA	0.2	1	18	20.0	21.1	1	29.2	13.7	0.514	39.3	59	0.291	9.2
SMAJ20A/CA	0.2	1	20	22.2	23.4	1	32.4	12.3	0.637	42.8	54	0.338	9.4
SMAJ24A/CA	0.2	1	24	26.7	28.1	1	38.9	10.3	0.912	50	46	0.446	9.6
SMAJ26A/CA	0.2	1	26	28.9	30.4	1	42.1	9.5	1.07	53.5	43	0.502	9.7
SMAJ28A/CA	0.2	1	28	31.1	32.7	1	45.4	8.8	1.26	59	39	0.632	9.8
SMAJ30A/CA	0.2	1	30	33.3	35.1	1	48.4	8.3	1.39	64.3	36	0.762	9.9
SMAJ33A/CA	0.2	1	33	36.7	38.6	1	53.3	7.5	1.70	69.7	33	0.884	10.0
SMAJ40A/CA	0.2	1	40	44.4	46.7	1	64.5	6.2	2.49	84	27	1.30	10.1
SMAJ43A/CA	0.2	1	43	47.8	50.3	1	69.4	5.7	2.91	91	25	1.53	10.2
SMAJ48A/CA	0.2	1	48	53.3	56.1	1	77.4	5.2	3.56	100	23	1.79	10.3
SMAJ58A/CA	0.2	1	58	64.4	67.8	1	93.6	4.3	5.21	121	19	2.62	10.4
SMAJ70A/CA	0.2	1	70	77.8	81.9	1	113	3.5	7.72	146	16	3.75	10.5
SMAJ85A/CA	0.2	1	85	94	99	1	137	2.9	11.4	178	13	5.70	10.6
SMAJ100A/CA	0.2	1	100	111	117	1	162	2.5	15.7	212	11	8.10	10.7
SMAJ130A/CA	0.2	1	130	144	152	1	209	1.9	26.0	265	9	11.7	10.8
SMAJ154A/CA	0.2	1	154	171	180	1	246	1.6	35.6	317	7	18.3	10.8
SMAJ170A/CA	0.2	1	170	189	199	1	275	1.4	47.2	353	6.5	22.2	10.8
SMAJ188A/CA	0.2	1	188	209	220	1	328	1.4	69.3	388	6	26.2	10.8

<sup>1.</sup> To calculate  $V_{BR}$  versus  $T_j$ :  $V_{BR}$  at  $T_j$  =  $V_{BR}$  at 25 °C x (1 +  $\alpha T$  x ( $T_j$  - 25))

4. Surge capability given for both directions for unidirectional and bidirectional devices

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<sup>2.</sup> To calculate  $V_{CL}$  versus  $T_j$ :  $V_{CL}$  at  $T_j$  =  $V_{CL}$  at 25 °C x (1 +  $\alpha T$  x ( $T_j$  - 25))

<sup>3.</sup> To calculate  $V_{CL}$  max versus  $I_{PPappli}$ :  $V_{CLmax} = V_{CL} - R_D \times (I_{PP} - I_{PPappli})$  where  $I_{PPappli}$  is the surge current in the application.

t<sub>p</sub> (ms)



200

100

25

50

### 1.1 Characteristics (curves)

junction temperature

P<sub>PP</sub> (W)

10/1000 μs

Figure 3. Maximum peak power dissipation versus initial

Figure 4. Maximum peak pulse power versus exponential pulse duration

Ppp (kW)

T<sub>j</sub> initial = 25 °C

Figure 5. Maximum peak pulse current versus clamping voltage

100

125

75

 $T_j$  (°C)

150

0.1 -

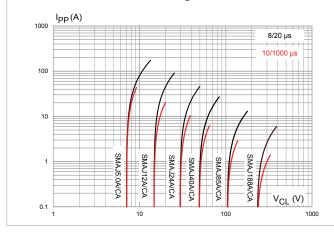


Figure 6. Dynamic resistance versus pulse duration

0.1

0.01

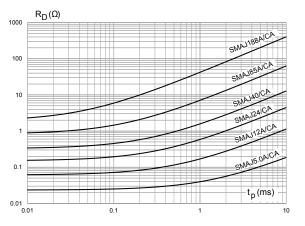


Figure 7. Junction capacitance versus reverse applied voltage (unidirectional type)

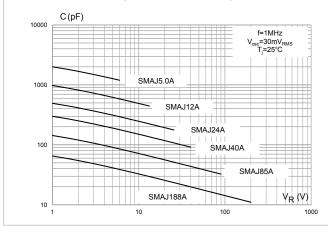
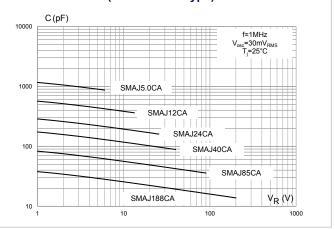


Figure 8. Junction capacitance versus applied voltage (bidirectional type)



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Figure 9. Leakage current versus junction temperature

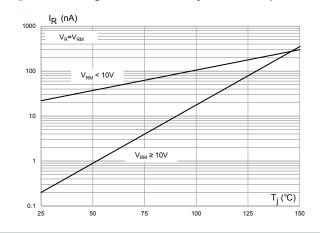


Figure 10. Peak forward voltage drop versus peak forward current

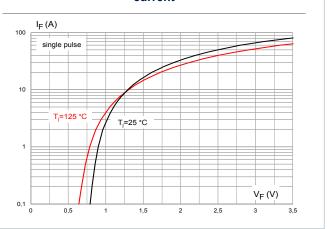


Figure 11. Thermal impedance junction to ambient versus pulse duration

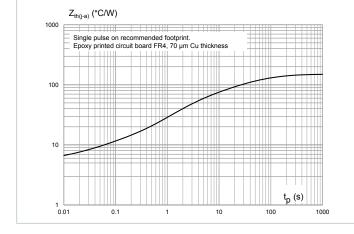
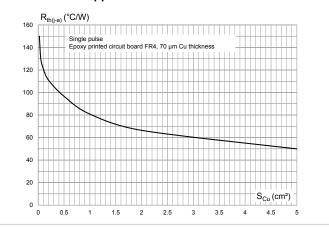


Figure 12. Thermal resistance junction to ambient versus copper area under each lead



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# 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

### 2.1 SMA package information

Figure 13. SMA package outline

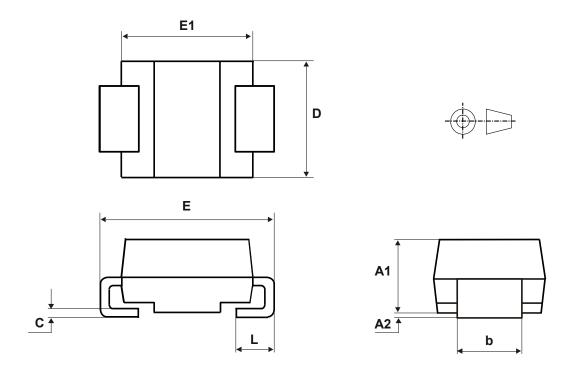


Table 3. SMA package mechanical data

	Dimensions							
Ref.	Millir	neters	Inches <sup>(1)</sup>					
	Min.	Max.	Min.	Max.				
A1	1.90	2.45	0.074	0.097				
A2	0.05	0.20	0.001	0.008				
b	1.25	1.65	0.049	0.065				
С	0.15	0.40	0.005	0.016				
D	2.25	2.90	0.088	0.115				
E	4.80	5.35	0.188	0.211				
E1	3.95	4.60	0.155	0.182				
L	0.75	1.50	0.029	0.060				

<sup>1.</sup> Values in inches are converted from mm.

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1.40 2.63 1.40 (0.055) (0.104) (0.055) 1.64 (0.065) 5.43 (0.214)

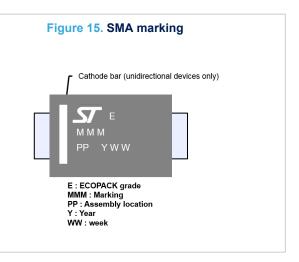
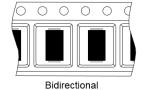
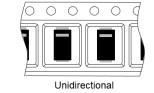


Figure 16. Package orientation in reel





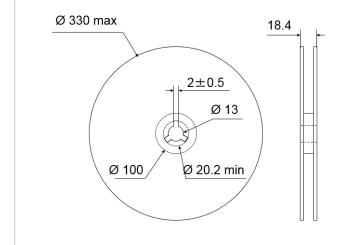
Taped according to EIA-481
Pocket dimensions are not on scale.
Pocket shape may vary depending on package

On bidirectional devices, marking and logo may not be always in the same direction.

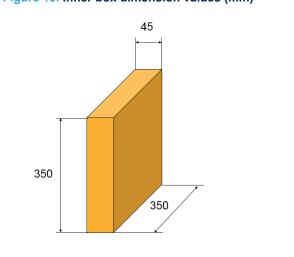
Maximum cover tape thickness 0.1 mm

Sprocket hole

Figure 18. 13" reel dimension values (mm)



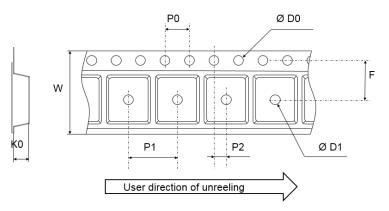




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Figure 20. Tape outline



Note: Pocket dimensions are not on scale Pocket shape may vary depending on package

Table 4. Tape dimension values

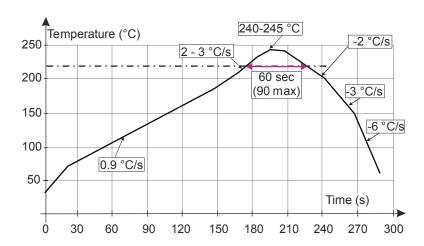
	Dimensions							
Ref.	Millimeters							
	Min.	Тур.	Max.					
D0	1.40	1.50	1.60					
D1	1.50							
F	5.40	5.50	5.60					
K0	2.26	2.36	2.46					
P0	3.90	4.00	4.10					
P1	3.90	4.00	4.10					
P2	1.95	2.00	2.05					
W	11.70	12.00	12.30					

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## 2.2 Reflow profile

Figure 21. ST ECOPACK recommended soldering reflow profile for PCB mounting



Note: Minimize air convection currents in the reflow oven to avoid component movement. Maximum soldering profile corresponds to the latest IPC/JEDEC J-STD-020.

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# 3 Ordering information

Table 5. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
SMAJxxA/CA-TR <sup>(1)</sup>	See Table 6. Marking.	SMA	71 mg	5000	Tape and reel

<sup>1.</sup> Where xx correspond to  $V_{RM}$  and A or CA indicates unidirectional or bidirectional version.

Table 6. Marking

Туре	Marking	Туре	Marking
SMAJ5.0A-TR	AE	SMAJ5.0CA-TR	AA
SMAJ6.0A-TR	DUB	SMAJ6.0CA-TR	DBB
SMAJ6.5A-TR	DUC	SMAJ6.5CA-TR	DBC
SMAJ8.5A-TR	DUH	SMAJ8.5CA-TR	DBH
SMAJ10A-TR	AX	SMAJ10CA-TR	AC
SMAJ12A-TR	DUK	SMAJ12CA-TR	DBK
SMAJ13A-TR	BG	SMAJ13CA-TR	ВН
SMAJ15A-TR	BM	SMAJ15CA-TR	AJ
SMAJ18A-TR	DUQ	SMAJ18CA-TR	DBQ
SMAJ20A-TR	DUR	SMAJ20CA-TR	DBR
SMAJ24A-TR	DUT	SMAJ24CA-TR	DBT
SMAJ26A-TR	DUU	SMAJ26CA-TR	DBU
SMAJ28A-TR	CG	SMAJ28CA-TR	СН
SMAJ30A-TR	CK	SMAJ30CA-TR	CL
SMAJ33A-TR	CM	SMAJ33CA-TR	CN
SMAJ40A-TR	DUZ	SMAJ40CA-TR	DBZ
SMAJ43A-TR	EUA	SMAJ43CA-TR	EBA
SMAJ48A-TR	CX	SMAJ48CA-TR	CY
SMAJ58A-TR	EUF	SMAJ58CA-TR	EBF
SMAJ70A-TR	EUI	SMAJ70CA-TR	EBI
SMAJ85A-TR	EUL	SMAJ85CA-TR	EBL
SMAJ100A-TR	EUN	SMAJ100CA-TR	EBN
SMAJ130A-TR	EUQ	SMAJ130CA-TR	EBQ
SMAJ154A-TR	EUT	SMAJ154CA-TR	EBT
SMAJ170A-TR	SR	SMAJ170CA-TR	SS
SMAJ188A-TR	EUV	SMAJ188CA-TR	EBV

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## **Revision history**

Table 7. Document revision history

Date	Revision	Changes
September-1998	5B	Previous update.
02-Aug-2004	6	SMA package dimensions update. Reference A1 max. changed from 2.70 mm (0.106) to 2.03 mm (0.080).
10-Dec-2004	7	Template layout update. No content change.
10-Feb-2006	8	Added unidirectional marking on cover page and Figure 14. Changed Figure 13. Foot print.
14-May-2009	9	Updated ECOPACK statement. Reformatted to current standards.
17-Sep-2009	10	Document updated for low leakage current.
05-Nov-2009	11	Corrected typographical error in Package information.
09-Jul-2010	12	Changed timescale in Figure 9.
18-May-2022	13	Updated Description, and Table 2.
10-Way-2022	13	Added product status links on coverpage.
31-May-2022	14	Updated product links table.
13-Jul-2023	15	Changed "Jedec DO214-AA" to "Jedec DO214-AC".

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